

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	14	((("5945213") or ("5639989") or ("5968600") or ("5014160") or ("6018460") or ("5704117") or ("6350951")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 13:03
L2	53	29/846,825,831,832,841,848,855, 856,428,460,469,525.ccls. and EMI adj shield\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:05
L3	5	427/96,103,118,258,265.ccls. and EMI adj shield\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:05
L4	435	174/35MS,35R,52.2.ccls. and EMI adj shield\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:05
L5	13	174/35MS,35R,52.2.ccls. and EMI adj shield\$3 with vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:06
L6	0	2577/659,660.ccls. and EMI adj shield\$3 with vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:06
L7	0	2577/659,660.ccls. and EMI adj shield\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:06
L8	37	257/659,660.ccls. and EMI adj shield\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:06
L9	1	257/659,660.ccls. and EMI adj shield\$3 with vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:06

L10	8	361/753,799,800,816.ccls. and EMI adj shield\$3 with vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 13:07
S1	351	ground\$3 with EMI adj shield	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 11:19
S2	134557	ground\$3 with EMI adj shieldwith conductive adj layer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 11:19
S3	6	ground\$3 with EMI adj shield with conductive adj layer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 11:21
S4	15	ground\$3 with EMI adj shield with ground adj trace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 11:30
S5	9	grounded adj EMI adj shield	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 15:01
S6	2	"5014160".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 15:58
S7	2	"20010033478"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 17:11
S8	63	metallized adj dielectric adj substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 17:12
S9	0	metallized adj dielectric adj substrate adj shield	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 17:12

S10	0	metallized adj dielectric adj substrate with frange	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 17:12
S11	0	metallized adj dielectric adj substrate with flange	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/14 17:13
S12	0	metallized adj dielectric adj substrate with ground adj trace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 12:52